



SMC 00-563

Application no. 09/863,224

May 11, 2003

TO: Commissioner of Patents
P.O. Box 1450
Alexandria VA 22313-1450

FROM: Stephen Ackerman Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

SUBJECT: Serial # 09/863,224 File Date: 05/24/2001
Inventor: Ming-Hsing Tsai
Examiner: Neal Berezny
Art Unit: 2823
Title: A Method To Solve Via Poisoning For Porous Low-K Dielectric

RECEIVED
JUN 10 2003
TECHNOLOGY CENTER 2800

RESPONSE TO FINAL OFFICE ACTION

This is in response to the Final Office Action dated 05/05/2003. Please amend the above identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to :
Commissioner of Patents P.O. Box 1450 Alexandria VA 22313-1450 on

July 3, 2003.

Signature [Signature] Date: July 3, 2003
Stephen B. Ackerman, Reg. No. 37,761